## : ©hipsmall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation, and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!


## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email \& Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, \#122 Zhenhua RD., Futian, Shenzhen, China

## Wide bandwidth dual JFET operational amplifiers

## Features

- Low power consumption
- Wide common-mode (up to $\mathrm{V}_{\mathrm{CC}}{ }^{+}$) and differential voltage range
- Low input bias and offset current
- Output short-circuit protection
- High input impedance JFET input stage
- Internal frequency compensation
- Latch up free operation
- High slew rate $16 \mathrm{~V} / \mu \mathrm{s}$ (typical)


## Description

These circuits are high speed JFET input dual operational amplifiers incorporating well matched, high voltage JFET and bipolar transistors in a monolithic integrated circuit.
The devices feature high slew rates, low input bias and offset currents, and low offset voltage temperature coefficient.


## 1 Schematics

Figure 1. Schematic diagram (each amplifier)


## 2 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage ${ }^{(1)}$ | $\pm 18$ | V |
| $V_{i}$ | Input voltage ${ }^{(2)}$ | $\pm 15$ | V |
| $V_{\text {id }}$ | Differential input voltage ${ }^{(3)}$ | $\pm 30$ | V |
| $\mathrm{R}_{\text {thja }}$ | Thermal resistance junction to ambient ${ }^{(4)}$ $\begin{aligned} & \text { SO-8 } \\ & \text { DIP8 } \end{aligned}$ | $\begin{gathered} 125 \\ 85 \end{gathered}$ | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\text {thic }}$ | Thermal resistance junction to case ${ }^{(4)}$ $\begin{aligned} & \text { SO-8 } \\ & \text { DIP8 } \end{aligned}$ | $\begin{aligned} & 40 \\ & 41 \end{aligned}$ | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | Output short-circuit duration ${ }^{(5)}$ | Infinite |  |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| ESD | HBM: human body model( ${ }^{(6)}$ | 1 | kV |
|  | MM: machine model ${ }^{(7)}$ | 200 | V |
|  | CDM: charged device model ${ }^{(8)}$ | 1.5 | kV |

1. All voltage values, except differential voltage, are with respect to the zero reference level (ground) of the supply voltages where the zero reference level is the midpoint between $\mathrm{V}_{\mathrm{CC}}{ }^{+}$and $\mathrm{V}_{\mathrm{CC}}{ }^{-}$.
2. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 volts, whichever is less.
3. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
4. Short-circuits can cause excessive heating and destructive dissipation. Values are typical.
5. The output may be shorted to ground or to either supply. Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded
6. Human body model: a 100 pF capacitor is charged to the specified voltage, then discharged through a $1.5 \mathrm{k} \Omega$ resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
7. Machine model: a 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < $5 \Omega$ ). This is done for all couples of connected pin combinations while the other pins are floating.
8. Charged device model: all pins and the package are charged together to the specified voltage and then discharged directly to the ground through only one pin. This is done for all pins.

Table 2. Operating conditions

| Symbol | Parameter | LF253 | LF353 | Unit |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage | 6 to 36 |  | V |
| $\mathrm{~T}_{\text {oper }}$ | Operating free-air temperature range | -40 to +105 | 0 to +70 | ${ }^{\circ} \mathrm{C}$ |

## 3 Electrical characteristics

Table 3. Electrical characteristics at $\mathrm{V}_{\mathrm{CC}}= \pm \mathbf{1 5} \mathrm{V}, \mathrm{T}_{\mathrm{amb}}=+\mathbf{2 5}{ }^{\circ} \mathrm{C}$ (unless otherwise specified)

| Symbol | Parameter | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {io }}$ | $\begin{aligned} & \text { Input offset voltage }\left(R_{\mathrm{s}}=10 \mathrm{k} \Omega\right) \\ & \mathrm{T}_{\min } \leq \mathrm{T}_{\mathrm{amb}} \leq \mathrm{T}_{\max } \end{aligned}$ |  | 3 | $\begin{aligned} & \hline 10 \\ & 13 \end{aligned}$ | mV |
| DV ${ }_{\text {io }}$ | Input offset voltage drift |  | 10 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{I}_{\text {io }}$ | Input offset current ${ }^{(1)}$ $\mathrm{T}_{\min } \leq \mathrm{T}_{\mathrm{amb}} \leq \mathrm{T}_{\max }$ |  | 5 | $\begin{gathered} 100 \\ 4 \end{gathered}$ | $\begin{aligned} & \mathrm{pA} \\ & \mathrm{nA} \end{aligned}$ |
| $\mathrm{l}_{\text {ib }}$ | $\begin{aligned} & \text { Input bias current }{ }^{(1)} \\ & T_{\min } \leq T_{\text {amb }} \leq T_{\max } \end{aligned}$ |  | 20 | $\begin{gathered} 200 \\ 20 \end{gathered}$ | $\begin{aligned} & \mathrm{pA} \\ & \mathrm{nA} \end{aligned}$ |
| $\mathrm{A}_{\mathrm{vd}}$ | Large signal voltage gain ( $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ ) $\mathrm{T}_{\min } \leq \mathrm{T}_{\mathrm{amb}} \leq \mathrm{T}_{\max }$ | $\begin{aligned} & 50 \\ & 25 \end{aligned}$ | 200 |  | V/mV |
| SVR | Supply voltage rejection ratio $\left(R_{S}=10 \mathrm{k} \Omega\right)$ $T_{\min } \leq T_{\mathrm{amb}} \leq \mathrm{T}_{\max }$ | $\begin{aligned} & 80 \\ & 80 \end{aligned}$ | 86 |  | dB |
| $\mathrm{I}_{\mathrm{CC}}$ | Supply current, no load $T_{\min } \leq T_{\text {amb }} \leq T_{\max }$ |  | 1.4 | $\begin{aligned} & \hline 3.2 \\ & 3.2 \end{aligned}$ | mA |
| $\mathrm{V}_{\mathrm{icm}}$ | Input common mode voltage range | $\pm 11$ | $\begin{aligned} & +15 \\ & -12 \end{aligned}$ |  | V |
| CMR | $\begin{aligned} & \text { Common mode rejection ratio }\left(R_{S}=10 \mathrm{k} \Omega\right) \\ & T_{\min } \leq T_{\text {amb }} \leq T_{\max } \end{aligned}$ | $\begin{aligned} & 70 \\ & 70 \end{aligned}$ | 86 |  | dB |
| los | Output short-circuit current $\mathrm{T}_{\min } \leq \mathrm{T}_{\mathrm{amb}} \leq \mathrm{T}_{\max }$ | $\begin{aligned} & \hline 10 \\ & 10 \end{aligned}$ | 40 | $\begin{aligned} & 60 \\ & 60 \end{aligned}$ | mA |
| $\pm \mathrm{V}_{\text {opp }}$ | Output voltage swing $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{~T}_{\min } \leq \mathrm{T}_{\text {amb }} \leq \mathrm{T}_{\max } \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 10 \\ & 12 \\ & \\ & 10 \\ & 12 \end{aligned}$ | $\begin{array}{\|c} 12 \\ 13.5 \end{array}$ |  | V |
| SR | Slew rate, $\mathrm{V}_{\mathrm{i}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$, unity gain | 12 | 16 |  | V/us |
| $\mathrm{t}_{\mathrm{r}}$ | Rise time, $\mathrm{V}_{\mathrm{i}}=20 \mathrm{mV}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$, unity gain |  | 0.1 |  | $\mu \mathrm{s}$ |
| $\mathrm{K}_{\mathrm{ov}}$ | Overshoot, $\mathrm{V}_{\mathrm{i}}=20 \mathrm{mV}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$, unity gain |  | 10 |  | \% |
| GBP | Gain bandwidth product, $f=100 \mathrm{kHz}, \mathrm{V}_{\text {in }}=10 \mathrm{mV}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$ | 2.5 | 4 |  | MHz |
| $\mathrm{R}_{\mathrm{i}}$ | Input resistance |  | $10^{12}$ |  | $\Omega$ |
| THD | Total harmonic distortion, $\mathrm{f}=1 \mathrm{kHz}, \mathrm{A}_{\mathrm{v}}=20 \mathrm{~dB}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$, $\mathrm{V}_{\mathrm{o}}=2 \mathrm{~V}_{\mathrm{pp}}$ |  | 0.01 |  | \% |
| $e_{n}$ | Equivalent input noise voltage $R_{S}=100 \Omega f=1 \mathrm{KHz}$ |  | 15 |  | $\frac{n \mathrm{~V}}{\sqrt{\mathrm{~Hz}}}$ |
| $\varnothing \mathrm{m}$ | Phase margin |  | 45 |  | Degrees |
| $\mathrm{V}_{01} / \mathrm{V}_{\mathrm{o} 2}$ | Channel separation ( $\mathrm{A}_{\mathrm{v}}=100$ ) |  | 120 |  | dB |

1. The input bias currents are junction leakage currents which approximately double for every $10^{\circ} \mathrm{C}$ increase in the junction
temperature.

Figure 2. Maximum peak-to-peak output voltage vs. frequency, $R_{L}=2 \mathrm{k} \Omega$


Figure 3. Maximum peak-to-peak output voltage vs. frequency, $R_{L}=10 \mathrm{k} \Omega$


Figure 4. Maximum peak-to-peak output voltage versus frequency


Figure 5. Maximum peak-to-peak output voltage versus free air temperature


Figure 6. Maximum peak-to-peak output voltage versus load resistance


Figure 8. Input bias current versus free air temperature


Figure 9. Large signal differential voltage amplification versus free air temp.

Figure 10. Large signal differential voltage amplification and phase shift versus frequency


Figure 12. Supply current per amplifier versus Figure 13. Supply current per amplifier versus free air temperature


Figure 14. Common mode rejection ratio versus free air temperature


Figure 15. Voltage follower large signal pulse response


Figure 16. Output voltage versus elapsed time Figure 17. Equivalent input noise voltage versus frequency


Figure 18. Total harmonic distortion versus frequency


## 4 Parameter measurement information

Figure 19. Voltage follower
Figure 20. Gain of 10 inverting amplifier


## 5 Typical application

Figure 21. Quadruple oscillator


## 6 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK ${ }^{\circledR}$ packages, depending on their level of environmental compliance. ECOPACK ${ }^{\circledR}$ specifications, grade definitions and product status are available at: www.st.com. ECOPACK ${ }^{\circledR}$ is an ST trademark.

### 6.1 DIP8 package information

Figure 22. DIP8 package mechanical drawing


Table 4. DIP8 package mechanical data

| Ref. | Dimensions |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Millimeters |  |  | Inches |  |  |
|  | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A |  |  | 5.33 |  |  | 0.210 |
| A1 | 0.38 |  |  | 0.015 |  |  |
| A2 | 2.92 | 3.30 | 4.95 | 0.115 | 0.130 | 0.195 |
| b | 0.36 | 0.46 | 0.56 | 0.014 | 0.018 | 0.022 |
| b2 | 1.14 | 1.52 | 1.78 | 0.045 | 0.060 | 0.070 |
| c | 0.20 | 0.25 | 0.36 | 0.008 | 0.010 | 0.014 |
| D | 9.02 | 9.27 | 10.16 | 0.355 | 0.365 | 0.400 |
| E | 7.62 | 7.87 | 8.26 | 0.300 | 0.310 | 0.325 |
| E1 | 6.10 | 6.35 | 7.11 | 0.240 | 0.250 | 0.280 |
| e |  | 2.54 |  |  | 0.100 |  |
| eA |  | 7.62 |  |  | 0.300 |  |
| eB |  |  | 10.92 |  |  | 0.430 |
| L | 2.92 | 3.30 | 3.81 | 0.115 | 0.130 | 0.150 |

### 6.2 SO-8 package information

Figure 23. SO-8 package mechanical drawing


Table 5. SO-8 package mechanical data

| Ref. | Dimensions |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Millimeters |  |  |  | Inches |  |  |
|  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| A |  |  | 1.75 |  |  | 0.069 |  |
| A1 | 0.10 |  | 0.25 | 0.004 |  | 0.010 |  |
| A2 | 1.25 |  |  | 0.049 |  |  |  |
| b | 0.28 |  | 0.48 | 0.011 |  | 0.019 |  |
| c | 0.17 |  | 0.23 | 0.007 |  | 0.010 |  |
| D | 4.80 | 4.90 | 5.00 | 0.189 | 0.193 | 0.197 |  |
| E | 5.80 | 6.00 | 6.20 | 0.228 | 0.236 | 0.244 |  |
| E1 | 3.80 | 3.90 | 4.00 | 0.150 | 0.154 | 0.157 |  |
| e |  | 1.27 |  |  | 0.050 |  |  |
| h | 0.25 |  | 0.50 | 0.010 |  | 0.020 |  |
| L | 0.40 |  | 1.27 | 0.016 |  | 0.050 |  |
| L1 |  | 1.04 |  |  | 0.040 |  |  |
| k | $1^{\circ}$ |  | $80^{\circ}$ | $1^{\circ}$ |  | $8^{\circ}$ |  |
| ccc |  |  | 0.10 |  |  | 0.004 |  |

## 7 Ordering information

Table 6. Order codes

| Order code | Temperature <br> range | Package | Packing | Marking |
| :--- | :---: | :---: | :---: | :---: |
| LF253N | $-40^{\circ} \mathrm{C},+105^{\circ} \mathrm{C}$ | DIP8 | Tube | LF253N |
| LF253D <br> LF253DT |  | Tube or <br> Tape \& reel | 253 |  |
| LF353N | $0^{\circ} \mathrm{C},+70^{\circ} \mathrm{C}$ | DIP8 | Tube | LF353N |
| LF353D <br> LF353DT |  | Tube or <br> Tape \& reel | 353 |  |

## 8 Revision history

Table 7. Document revision history

| Date | Revision | Changes |
| :---: | :---: | :--- |
| 01-Mar-2001 | 1 | Initial release. |
| 08-Sep-2008 | 2 | Updated document format. <br> Removed information concerning military temperature range <br> (LF153). <br> Added L1 parameter dimensions in Table 5: SO-8 package <br> mechanical data. |
| 25-Mar-2010 | 3 | Corrected error in Table 6: Order codes: LF253N, LF253D, LF353N <br> and LF353D proposed in tube packing. |

## Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.
Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER’S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries
Information in this document supersedes and replaces all information previously supplied.
The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.
© 2010 STMicroelectronics - All rights reserved

STMicroelectronics group of companies
Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

